**附件3-2**

编号

**厦门市集成电路产业高端人才申报书**

申 报 人 （中文） （英文或拼音）

申报单位

联系人

联系电话 （办公） （手机）

申报日期 年 月 日

厦门市集成电路产业发展工作领导小组办公室

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| 姓名 | 中文 | | |  | | | | | | | | 性别 | | | | |  | | | |  | |
| 英文 | | |  | | | | | | | | 出生年月 | | | | |  | | | |
| 国籍 | | | |  | | | | | | | | 户籍 | | | | |  | | | |
| 身份证号码  (护照号码) | | | |  | | | | | | | | 联系地址 | | | | |  | | | | | |
| 电话 | | | |  | | | | | | | | E-Mail | | | | |  | | | | | |
| 首次来厦工作时间（年月） | | | |  | | | | | | | | 合同期限 | | | | |  | | | | | |
| 在厦工作时间 | | | |  | | | | | | | | 专业领域（方向） | | | | |  | | | | | |
| 申请人才类别 | | | | A类（ ）  B类（ ）  C类（ ） | | | | | | | | 对应条件 | | | | |  | | | | | |
| 最高学历学位情况 | | | | ------- | | 学位 | | | | | | 毕业院校 | | | | | | | 专业 | | | |
| 中文 | |  | | | | | |  | | | | | | |  | | | |
| 英文 | |  | | | | | |  | | | | | | |  | | | |
| 来厦前 | | | | ------- | | 工作单位 | | | | | | | | | | | | | 职务 | | | |
| 中文 | |  | | | | | | | | | | | | |  | | | |
| 英文 | |  | | | | | | | | | | | | |  | | | |
| **教育经历** | | | | | | | | | | | | | | | | | | | | | | |
| （按时间顺序从本科填起，若为国外教育请加注英文） | | | | | | | | | | | | | | | | | | | | | | |
| 学位 | | 开始年月 | | | | 结束年月 | | | 国家 | | | | 院校 | | | | | | 专业 | | | |
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| **工作经历** | | | | | | | | | | | | | | | | | | | | | | |
| （按时间顺序填写, 兼职请注明, 若为国外工作请加注英文） | | | | | | | | | | | | | | | | | | | | | | |
| 职务 | | | 开始年月 | | | | 结束年月 | | | | 国家 | | | | 单位 | | | | | | | |
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| **专长及代表性成果（一）** | | | | | | | | | | | | | | | | | | | | | | |
| **1、个人专长（300字以内）** | | | | | | | | | | | | | | | | | | | | | | |
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| **2、近五年领导（参与）过的主要项目（金额单位：万元）** | | | | | | | | | | | | | | | | | | | | | | |
| 开始时间 | | | 结束时间 | | | | | 项目性质和来源 | | | | | | 经费总额 | | | 参与人数 | 申报人具体职位和任务 | | | | |
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| **3、近五年主要成果** | | | | | | | | | | | | | | | | | | | | | | |
| （1）近五年代表性论著（论文） | | | | | | | | | | | | | | | | | | | | | | |
| 发表时间 | | | 论著（论文）名称 | | | | | | | | | | | 发表载体 | | | | 论著（论文）作者 | | | | |
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| **专长及代表性成果（二）** | | | | | | | | | | | | | | | | | | | | | | |
| （2）近五年专利（请填报已授权的专利，并在附件中上传专利证书和专利说明书） | | | | | | | | | | | | | | | | | | | | | | |
| 专利名称 | | | | | 专利号 | | | | | 在发明人当中的排名 | | | | | | 专利保护期 | | | | 专利权人 | | 专利授权国 |
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| （3）其他近五年的显著业绩表现（200字以内） | | | | | | | | | | | | | | | | | | | | | | |
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| **4、近五年领导创新团队、建设学术梯队、培育青年人才情况** | | | | | | | | | | | | | | | | | | | | | | |
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| **5、其他(包括近五年获得的重要奖项、在国际学术组织兼职、在国际学术会议做重要报告等情况)（300字以内）** | | | | | | | | | | | | | | | | | | | | | | |
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| **用人单位有项目协议、工作计划、工作目标** | | | | | | | | | | | | | | | | | | | | | | |
| **1、工作目标及内容（包括来厦后主要研究、研发内容与目标，主要突破的核心问题及产业核心技术等）** | | | | | | | | | | | | | | | | | | | | | | |
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| **2、工作方式及进度安排（包括来厦的主要工作方式，如全职或兼职，每年在厦的时间安排，对工作目标和内容的进度安排等）** | | | | | | | | | | | | | | | | | | | | | | |
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| **3、创新性描述（包括所研究领域创新性的描述，其在国内外的主要现状和趋势，研究课题对厦门相应学科、产业的意义和作用等）** | | | | | | | | | | | | | | | | | | | | | | |
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| **4、现有基础（现有的团队、技术基础，拥有的自主知识产权状况、成果的关键核心技术，现有的研发资金情况，团队主要成员情况等）** | | | | | | | | | | | | | | | | | | | | | | |
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| **5、预期贡献（研究课题预计产生的经济和社会效益）** | | | | | | | | | | | | | | | | | | | | | | |
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| **6、所需支持（希望得到的进一步支持，包括资金、政策等方面的支持）** | | | | | | | | | | | | | | | | | | | | | | |
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| 您是否和其他任何单位签订过仍然有效的竞业禁止协议，如果有，请列出。（200字以内） | | | | | | | | | | | | | | | | | | | | | | |
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| **用人单位意见** | | | | | | | | | | | | | | | | | | | | | | |
| 1、推荐理由(300字以内) | | | | | | | | | | | | | | | | | | | | | | |
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| 2、支持条件（包括工作和生活等方面）（200字以内） | | | | | | | | | | | | | | | | | | | | | | |
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| 申报人有关信息属实，本单位承诺予以上述支持，特推荐申报“厦门市集成电路高端人才”。  主要负责人签 单位（公章）  年 月 日 | | | | | | | | | | | | | | | | | | | | | | |
| **专家评审意见** | | | | | | | | | | | | | | | | | | | | | | |
| 专家组签字：  年    月   日 | | | | | | | | | | | | | | | | | | | | | | |
| 说明：1.对应条件指满足《厦门市集成电路产业高端人才评定标准》A、B、C三类人才规定具体条件，申报人需提供相应依据。  2.境外人才需每年在境内居住满183天。 | | | | | | | | | | | | | | | | | | | | | | |